



Thick Film Chip Resistor Arrays

(Lead-Free for CNCR24 Concave Reverse Type)

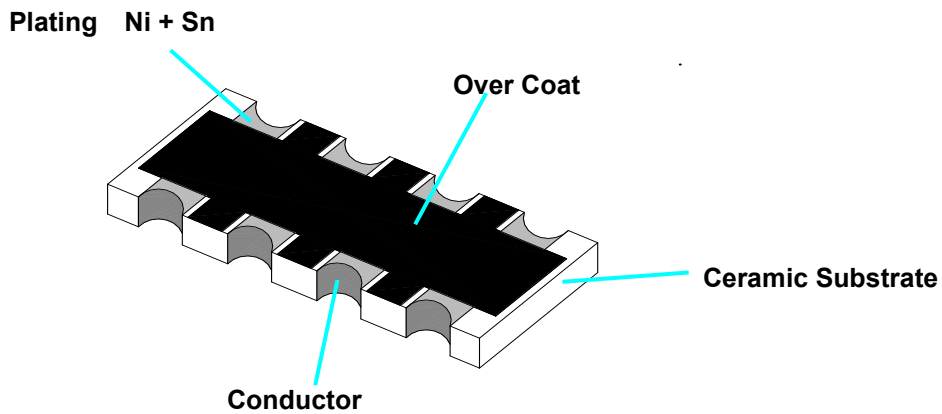
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1. Scope :

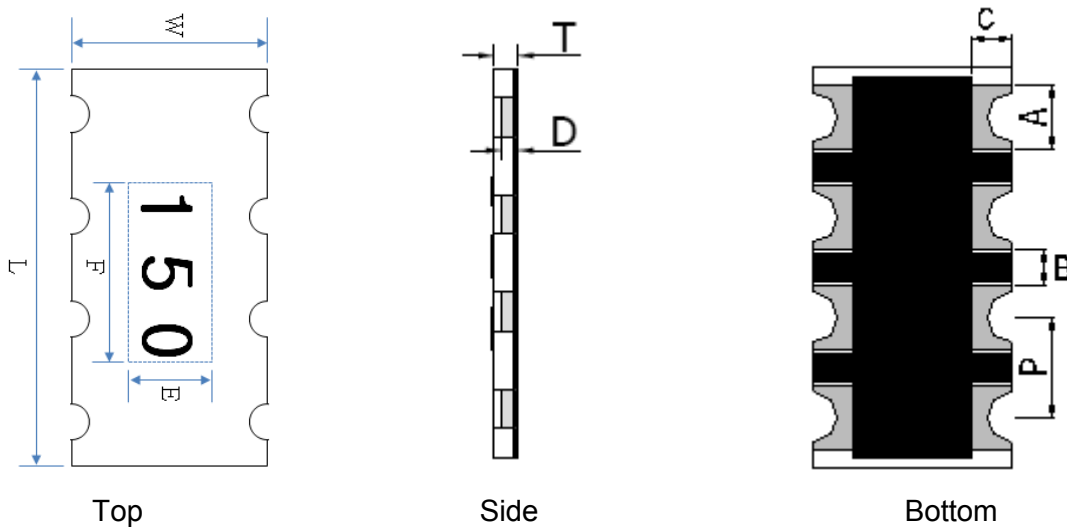
This specification applies for the CNCR24 Concave Type of thick film chip resistor arrays made by TA-I.

2. Construction , Dimensions , Schematic :

2.1 Construction :



2.1.1 Chip Resistor Arrays :



2.2 Dimension :

UNIT:mm

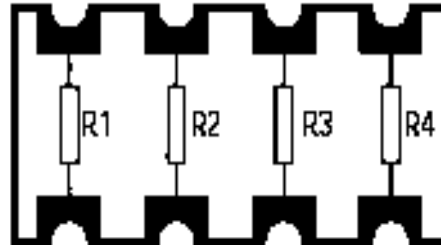
Type	L	W	T	A	B	C	D	P
CNCR24	2.0±0.1	1.0±0.1	0.45±0.1	0.3±0.1	0.15±0.1	0.25±0.1	>0.6T	0.50±0.1



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2.3 Schematic



$R1=R2=R3=R4$

3. Type Designation:

3.1 Chip Resistor Arrays

CNCR

24

J

TN

102

Product Code size Tolerance Packaging Nominal Resistance
 CNCR: Chip Resistor Arrays Power Rating
 Concave Reverse type

24-0402*4

J-±5%
F-±1%

T- Paper Tape
N - Lead Free

3 digits e.g.,:
(E-24) 102 = 1KΩ
4 digits E.G. :
(E-96) 1540 = 154Ω



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4. Ratings & Characteristics :

Type	Power Rating at 70°C	Rating Voltage	Max. Working Voltage	Max. OverLoad Voltage	Operating Temp.(°C)	Resistance Tolerance(%)	Resistance Range (Ω)	Temp Coefficient PPM/°C
CNCR24	1/16W	Refer 4.2	25V	50V	-55-+125°C	±5%	10Ω ~ 1MΩ	≤±300

0Ω THICK FILE CHIP RESISTOR ARRAYS			
Type	Rated Current	Max Overload Current	Resistance Range
CNCR 24	1A	2.5 A	50mΩ MAX

4.1 Derating Curve :

For resistors operated at ambient temperature over 70°C , power rating shall be derated in accordance with figure 1.

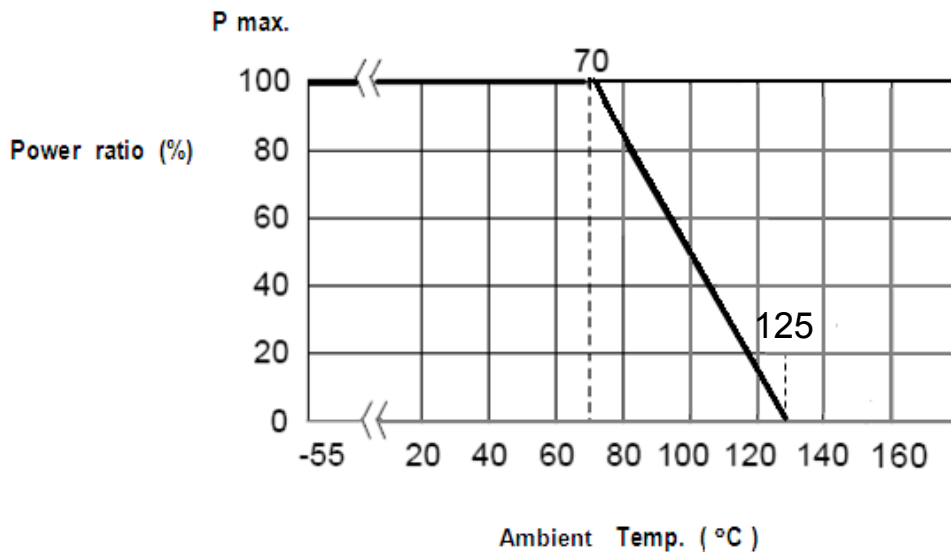


Figure 1

4.2 Rated Voltage:

The rated voltage is calculated by the following formula:

$$E = \sqrt{P * R}$$

E=Rated Voltage(V)
 P=Rated Power(W)
 R=Resistance Value(Ω)

E.G. : What is CNCR24JTN102 the rated voltage ?

CNCR24JTN102 P:1/16W ; R:102 = 1KΩ = 1000Ω

$$E = \sqrt{0.0625(W) * 1000(\Omega)} = 7.9 (V)$$



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5. Reliability Tests:

Test Items	Reference standard	Condition of Test	Test Limits ($\Delta R/R$)
Temperature Coefficient of Resistance	IEC60115-1-4.8 JIS-C5201-1-4.8	-55~ +125 °C	Refer 4.0
Short Time Overload	IEC60115-1-4.13 JIS-C5201-1-4.13	2.5 X rated voltage for 5 sec	$\pm (2.0 \% + 0.1\Omega)$ 0 Ω : 50m Ω or less
Intermittent Overload	IEC60115-1-4.39 JIS-C5201-1-4.39	2.5X rated voltage or Max Overloading Voltage , 1 sec "ON" 25 sec "OFF" , 10000 cycles	$\pm (5.0 \% + 0.1\Omega)$ 0 Ω : 50m Ω or less
Load Life	IEC60115-1-4.25.1 JIS-C5201-1-4.25.1	1000 hours at rated voltage , 70°C , 1.5hours "ON " , 0.5hour "OFF"	1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(3.0\%+0.1\Omega)$ 0 Ω : 100m Ω or less
Load Life with Humidity	IEC60115-1-4.24 JIS-C5201-1-4.24	1000 hours at rated voltage , 40 \pm 2°C , 90~95% RH 1.5hours "ON " , 0.5hour "OFF"	1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(3.0\%+0.1\Omega)$ 0 Ω : 100m Ω or less
Rapid Change of Temperature	IEC60115-1-4.19 JIS-C5201-1-4.19	-55°C (30 min.) / +125 °C (30 min.) 5 cycles	1%: $\pm(0.5\%+0.05\Omega)$ 5%: $\pm(1.0\%+0.05\Omega)$ 0 Ω : 50m Ω or less
Solderability	IEC60115-1-4.17 JIS-C5201-1-4.17	245 \pm 5°C solder, 2 \pm 0.5 sec dwell. Solder : Sn96.5 / Ag3.0 / Cu0.5	At least 95% of surface area of electrode shall be covered with new solder.
Core body	IEC60115-1-4.15 JIS-C5201-1-4.15	Pressure 1.0 kgf a R0.5 pressure rod for 10 sec	Without mechanical damage such as breaks. Electrical characteristics shall be satisfied
Dielectric Withstanding Voltage (Voltage Proof)	IEC60115-1-4.7 JIS-C5201-1-4.7	Applying voltage 100V for 1 minute.	No abnormalities such as flashover, burning dielectric breakdown shall appear.
Resistance to Solder Heat	IEC60115-1-4.18 JIS-C5201-1-4.18	270 \pm 5°C solder , 10 \pm 1 sec dwell .	1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.1\Omega)$ 0 Ω : 50m Ω or less

Note* : RCWV : Rated continuous working voltage .

6. Marking

6.1 $\pm 5\%$ (E24)

Resistance value is expressed by 3 digits, the first two digits represent the significant figures of nominal resistance value in Ω , and the third digit represents exponent for base of 10.

E.G. 102 = $10 \times 10^2 = 1K\Omega$



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6.2 ±1% (E96)

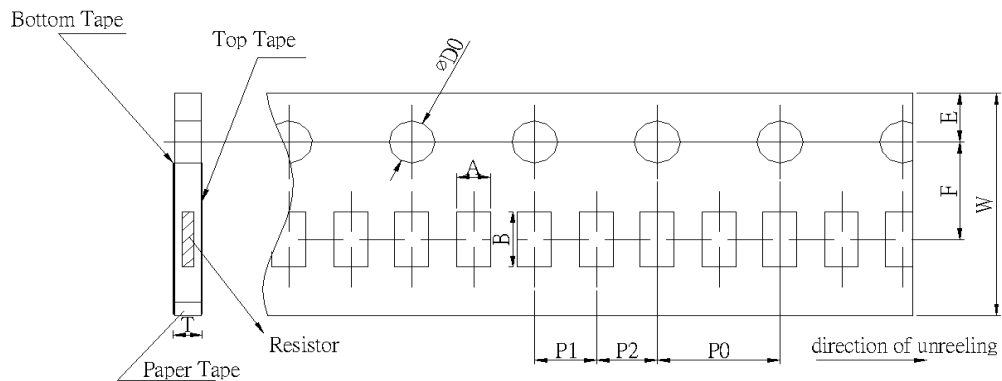
Resistance value is expressed by 4 digits, the first three digits represent the significant figures of nominal resistance value in Ω , and the fourth digit represents exponent for base of 10.

E.G. 4701 = $470 \times 10^1 = 4700 \Omega = 4.7k\Omega$

7. Taping & Reel

7.1 Taping Dimensions

7.1.1 2 mm pitch paper

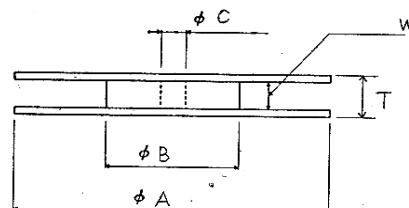
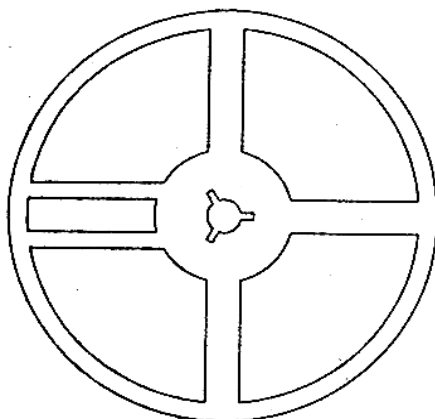


UNIT: mm

Type	A	B	W	F	E	P1	P2	P0	$\phi D0$	T0
CNCR24	1.2±0.1	2.2±0.1	8.0±0.2	3.5±0.05	1.75±0.1	2.0±0.05	2.0±0.05	4.0±0.1	1.5 +0.1 -0	0.6 +0.2 -0

Package Type	Paper Tape
	2 mm pitch
	178mm / R
CNCR24	10000

7.2 Reel Specifications





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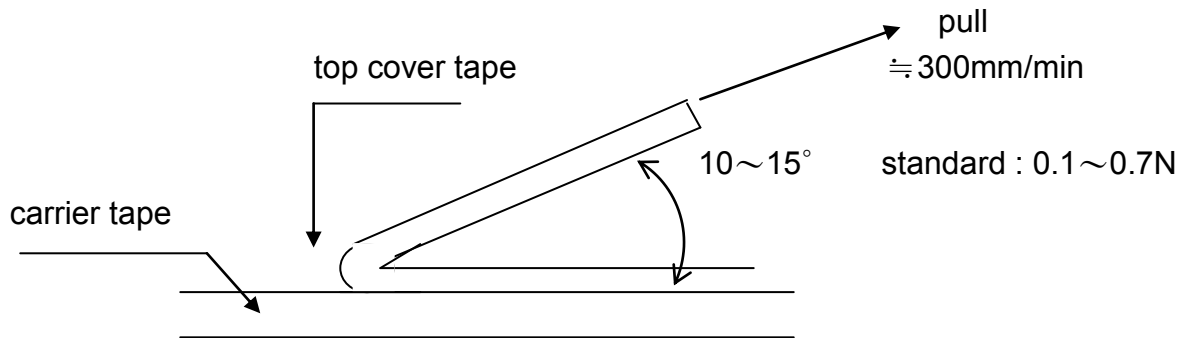
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UNIT: mm

Type	ϕA	ϕB	ϕC	W	T
CNCR24	178.0 ± 2.0	60 or more	13.0 ± 1.0	9.0 ± 1.0	11.5 ± 1.0

7.3 Peel off Strength:

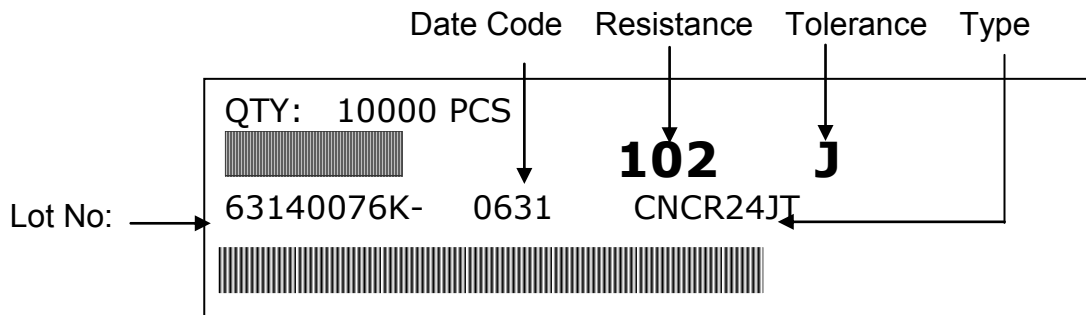
Peel-off force of paper and blister tape is in accordance with "JIS-C5202" that is, 0.1 to 0.7 N at a peel-off speed of 300 mm / minute.



8. Label

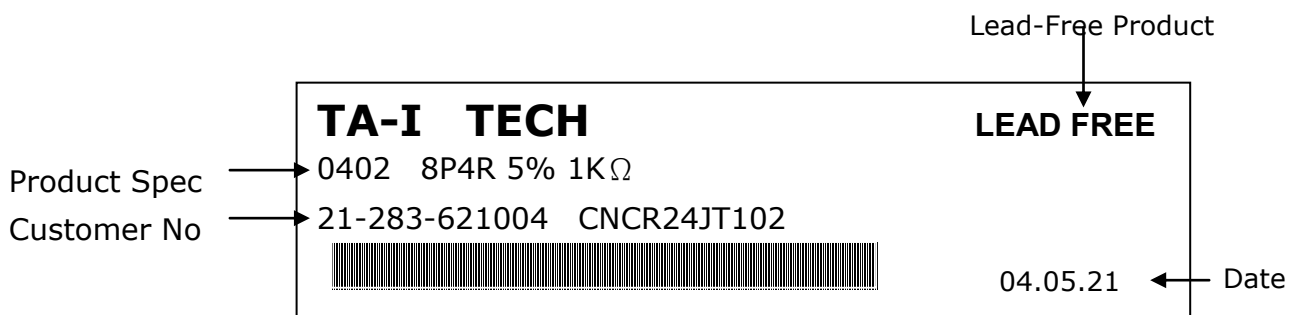
8.1 Manufacture Label :

8.1.1 Chip Resistor Arrays



8.2. Customer Label (By customer request) :

8.2.1 Chip Resistor Arrays



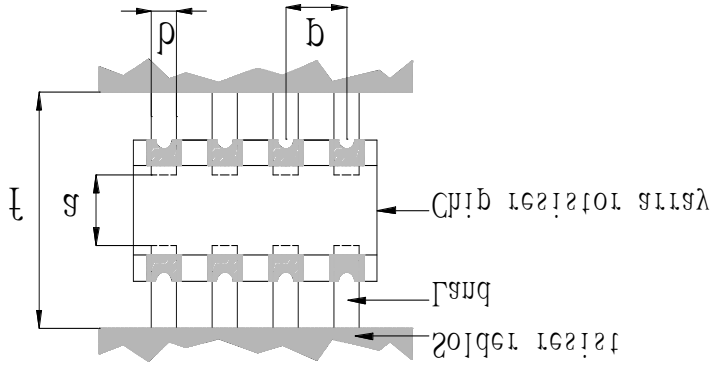


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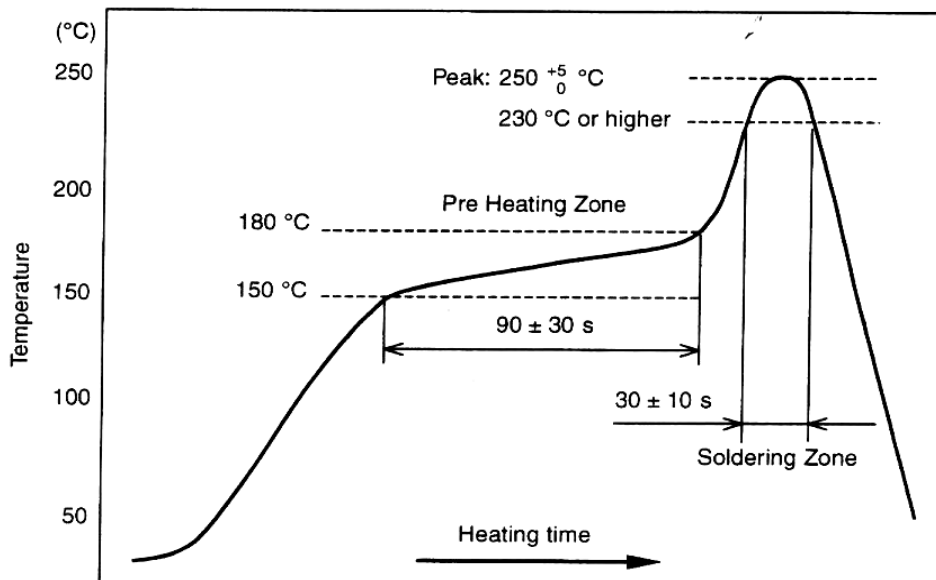
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9. Recommended land patterns



Type	Size	Land pattern	Dimension (mm)			
			a	b	p	f
CNCR	24		0.4~0.5	0.25~0.3	0.5	2.0

10. Recommend IR – Reflow profile : (solder : Sn96.5 / Ag3 / Cu0.5)



Peak : 250 $\begin{matrix} +5 \\ -0 \end{matrix}$ °C , 5 sec
 Pre - heat Zone : 150 to 180 °C , 90 ± 30 sec
 Soldering Zone : 230°C or higher , 30 ± 10 sec



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11. Storage Conditions:

Temperature : 5 to 35 °C
Related Humidity :40 to 75% RH

12. Shelf Life :

2 Years from manufacturing date.

13. ECN :

Engineering Change Notice: The customer will be informed with ECN if there is significant modification on the characteristics and materials described in Approval Sheet.

14. Manufacturing Country & City :

TA-I TECHNOLOGY CO., LTD. (Taiwan – Tao Yuan)
Tel: 886-3-3246169 Fax : 886-3-3246167

Associated companies :

- (1) FORTUNE TASK RESISTOR FACTORY (China – Dongguan)
Tel : 86-769-8339-4790~3 Fax : 86-769-8339-4794
- (2) TA-I TECHNOLOGY (DONGGUAN) CO., LTD. (China –Dongguan)
Tel : 86-769-8339-4790~3 Fax : 86-769-8339-4794
- (3) TA-I TECHNOLOGY (SU ZHOU) CO., LTD. (China – Su Zhou)
Tel :86- 512-63457879 Fax : 86-512-63457869
- (4) TAI OHM ELECTRONICS (M) SDN. BHD. (Malaysia – Pulaupinang)
Tel :604- 3900480 Fax : 604-3901481
- (5) P.T.TAI ELECTRONICS Indonesia (Indonesia – Jakarta)
Tel :62-21-89830123 Fax : 62-21-89830703